## **Amendment to the Specification:**

Please amend  $\P[0028]$  as follows:

[0028] With reference to FIGURE 1 FIGURE 5, there is shown an LED A, including an exemplary die or chip 100 mounted or being mounted to a support 200 (e.g., a mount, a sub-mount, a printed circuit board (PCB), a reflector cup, etc.) via a plurality of bonding bumps 300. While the LED A is illustrated for exemplary purposes herein, it is to be appreciated that device may be another suitable and/or similar light emitting device, or other suitable and/or similar semiconductor device.